

AMENDMENTS TO THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the application:

LISTING OF CLAIMS:

Claims 1-19 (Canceled)

Claim 20 (Previously Presented): A composition comprising a polyamide matrix, comprising:

at least 2% by weight of electrically conductive fillers; and

1% to 30% by weight of an antistatic agent comprising a polyetheramide; the percentages by weight being expressed with respect to the total weight of the composition.

Claim 21 (Previously Presented): The composition as claimed in claim 20, exhibiting a surface resistivity of between $10^5 \Omega$ and $10^{11} \Omega$, measured according to Standard IEC 61340-4-1.

Claim 22 (Previously Presented): The composition as claimed in claim 20, having a discharge time of greater than or equal to 10 seconds, measured according to Standard IEC 61340-5-1.

Claim 23 (Previously Presented): The composition as claimed in claim 20, having from 2 to 50% by weight of electrically conductive fillers, with respect to the

total weight of the composition.

Claim 24 (Previously Presented): The composition as claimed in claim 20, wherein the electrically conductive fillers are a carbon black, a metal, a graphite, a conductive polymer, a glass or an inorganic filler coated with a metal layer.

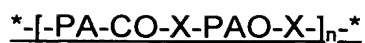
Claim 25 (Previously Presented): The composition as claimed in claim 20, having from 2 to 10% by weight of carbon black as electrically conductive fillers, with respect to the total weight of the composition.

Claim 26 (Previously Presented): The composition as claimed in claim 20, having from 1 to 30% by weight of antistatic agent, with respect to the total weight of the composition.

Claim 27 (Previously Presented): The composition as claimed in claim 20, wherein the antistatic agent further comprises a sodium alkylsulfonate, an alkylbenzenesulfonate, primary, secondary or tertiary amines, an ethoxylated amine, an ethoxylated alcohol, glyceryl monostearates, distearates or tristearates.

Claim 28 (Currently Amended): The composition as claimed in claim 20, wherein the antistatic agent is a polyetheramide represented by the formula (I):





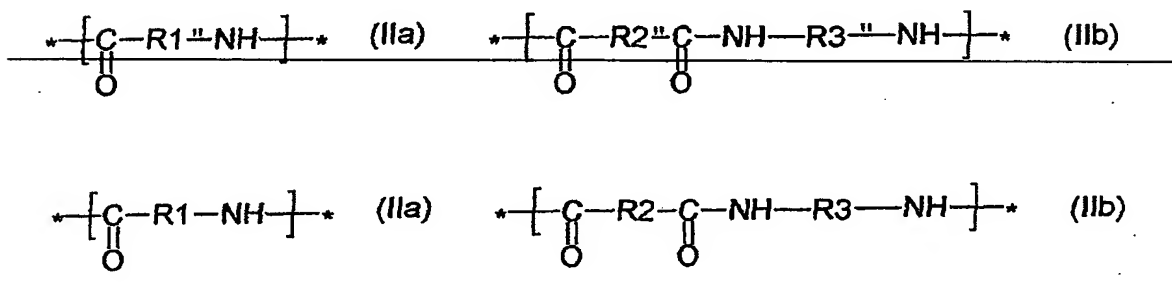
in which:

n is an integer between 5 and 50;

X represents an oxygen atom or an NH group;

PAO represents a poly(alkylene oxide) block;

PA represents a polyamide block, the repeat unit of which is represented by either of the formulae (IIa) or (IIb):



in which: R¹, R² and R³ are aromatic or aliphatic radicals having 4 to 36 carbon atoms.

Claim 29 (Previously Presented): The composition as claimed in claim 28, wherein the radical R¹ is a linear divalent pentyl radical.

Claim 30 (Previously Presented): The composition as claimed in claim 28, wherein the PAO block is a poly(ethylene oxide) block.

Claim 31 (Currently Amended): The composition as claimed in claim 20, wherein the polyamide matrix is formed from at least one (co)polyamide which is: **[[.]]**

(co)polyamide 6; 4; 11; 12; 4,6; 6,6; 6,9; 6,10; 6,12; 6,18; 6,36; 6(T); 9(T); 6(I); MXD6; their copolymers or their blends.

Claim 32 (Previously Presented): The composition as claimed in claim 20, wherein the composition further comprises at least one modifier of the impact strength selected from the group consisting of: ethylene-propylene (EP) optionally grafted with maleic anhydride, ethylene-propylene-diene (EPDM) terpolymer optionally grafted with maleic anhydride, styrene-maleic anhydride (SMA), ultra-low-density polyethylene (ULDPE), linear low density polyethylene (LLDPE), styrene-butadiene (SBS and SBR) compounds, styrene-ethylene-butadiene-styrene (SEBS) compounds, polypropylene (PP), acrylic elastomers, copolymers and terpolymers of ethylene with acrylic or methacrylic derivatives and/or with vinyl acetate, ionomers, acrylonitrile-butadiene-styrene (ABS) terpolymer and acrylic-styrene-acrylonitrile (ASA) terpolymer.

Claim 33 (Previously Presented): A process for the preparation of a polyamide composition as claimed in claim 20, comprising blending at least 2% by weight of electrically conductive fillers and at least 1% by weight of antistatic agents with a polyamide matrix, optionally in the molten state.

Claim 34 (Previously Presented): A process for the preparation of a polyamide composition as claimed in claim 20, comprising blending the polyamide matrix with:
a concentrated blend based on a thermoplastic matrix comprising at least 20% by weight of electrically conductive fillers, and

at least 1% by weight of antistatic agents.

Claim 35 (Previously Presented): The process as claimed in claim 34, wherein the thermoplastic matrix is selected from the group consisting of: the (co)polyamide, ethylene-vinyl acetate (EVA) copolymer, ethylene-acrylic acid (EAA), polyethylene (PE), polypropylene (PP), their copolymers and their blends.

Claim 36 (Previously Presented): A process for the manufacture of an article, comprising forming an article from a composition as claimed in claim 20 by an extrusion process, a molding process or an injection process.

Claim 37 (Previously Presented): An article obtained from the composition as claimed in claim 20.

Claim 38 (Previously Presented): The article as claimed in claim 37, painted by a process of applying a paint by electrostatic deposition.

Claim 39 (Previously Presented): A process for producing an article, comprising forming an article from the composition of claim 20, and applying paint to the article by electrostatic deposition.